

# SGU2N60UFD

## Ultra-Fast IGBT

### General Description

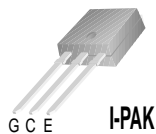
Fairchild's UFD series of Insulated Gate Bipolar Transistors (IGBTs) provides low conduction and switching losses. The UFD series is designed for applications such as motor control and general inverters where high speed switching is a required feature.

### Features

- High speed switching
- Low saturation voltage :  $V_{CE(sat)} = 2.1 \text{ V @ } I_C = 1.2\text{A}$
- High input impedance
- CO-PAK, IGBT with FRD :  $t_{rr} = 45\text{ns (typ.)}$

### Applications

AC & DC motor controls, general purpose inverters, robotics, and servo controls.



### Absolute Maximum Ratings $T_C = 25^\circ\text{C}$ unless otherwise noted

Symbol	Description	SGU2N60UFD	Units
$V_{CES}$	Collector-Emitter Voltage	600	V
$V_{GES}$	Gate-Emitter Voltage	$\pm 20$	V
$I_C$	Collector Current @ $T_C = 25^\circ\text{C}$	2.4	A
	Collector Current @ $T_C = 100^\circ\text{C}$	1.2	A
$I_{CM(1)}$	Pulsed Collector Current	10	A
$I_F$	Diode Continuous Forward Current @ $T_C = 100^\circ\text{C}$	1.5	A
$I_{FM}$	Diode Maximum Forward Current	12	A
$P_D$	Maximum Power Dissipation @ $T_C = 25^\circ\text{C}$	25	W
	Maximum Power Dissipation @ $T_C = 100^\circ\text{C}$	10	W
$T_J$	Operating Junction Temperature	-55 to +150	$^\circ\text{C}$
$T_{stg}$	Storage Temperature Range	-55 to +150	$^\circ\text{C}$
$T_L$	Maximum Lead Temp. for Soldering Purposes, 1/8" from Case for 5 Seconds	300	$^\circ\text{C}$

**Notes :**

(1) Repetitive rating : Pulse width limited by max. junction temperature

### Thermal Characteristics

Symbol	Parameter	Typ.	Max.	Units
$R_{\theta JC}$ (IGBT)	Thermal Resistance, Junction-to-Case	--	5.0	$^\circ\text{C/W}$
$R_{\theta JC}$ (DIODE)	Thermal Resistance, Junction-to-Case	--	5.0	$^\circ\text{C/W}$
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient	--	110	$^\circ\text{C/W}$

**Electrical Characteristics of the IGBT**  $T_C = 25^\circ\text{C}$  unless otherwise noted

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
<b>Off Characteristics</b>						
$BV_{CES}$	Collector-Emitter Breakdown Voltage	$V_{GE} = 0V, I_C = 250\mu A$	600	--	--	V
$\Delta BV_{CES}/\Delta T_J$	Temperature Coefficient of Breakdown Voltage	$V_{GE} = 0V, I_C = 1mA$	--	0.6	--	$V/^\circ\text{C}$
$I_{CES}$	Collector Cut-Off Current	$V_{CE} = V_{CES}, V_{GE} = 0V$	--	--	250	$\mu A$
$I_{GES}$	G-E Leakage Current	$V_{GE} = V_{GES}, V_{CE} = 0V$	--	--	$\pm 100$	nA

**On Characteristics**

$V_{GE(th)}$	G-E Threshold Voltage	$I_C = 1.2mA, V_{CE} = V_{GE}$	3.5	4.5	6.5	V
$V_{CE(sat)}$	Collector to Emitter Saturation Voltage	$I_C = 1.2A, V_{GE} = 15V$	--	2.1	2.6	V
		$I_C = 2.4A, V_{GE} = 15V$	--	2.6	--	V

**Dynamic Characteristics**

$C_{ies}$	Input Capacitance	$V_{CE} = 30V, V_{GE} = 0V,$ $f = 1MHz$	--	98	--	pF
$C_{oes}$	Output Capacitance		--	18	--	pF
$C_{res}$	Reverse Transfer Capacitance		--	4	--	pF

**Switching Characteristics**

$t_{d(on)}$	Turn-On Delay Time	$V_{CC} = 300V, I_C = 1.2A,$ $R_G = 200\Omega, V_{GE} = 15V,$ Inductive Load, $T_C = 25^\circ\text{C}$	--	15	--	ns	
$t_r$	Rise Time		--	20	--	ns	
$t_{d(off)}$	Turn-Off Delay Time		--	80	130	ns	
$t_f$	Fall Time		--	95	160	ns	
$E_{on}$	Turn-On Switching Loss		--	30	--	$\mu J$	
$E_{off}$	Turn-Off Switching Loss		--	13	--	$\mu J$	
$E_{ts}$	Total Switching Loss		--	43	70	$\mu J$	
$t_{d(on)}$	Turn-On Delay Time		$V_{CC} = 300V, I_C = 1.2A,$ $R_G = 200\Omega, V_{GE} = 15V,$ Inductive Load, $T_C = 125^\circ\text{C}$	--	19	--	ns
$t_r$	Rise Time			--	24	--	ns
$t_{d(off)}$	Turn-Off Delay Time			--	115	200	ns
$t_f$	Fall Time	--		176	250	ns	
$E_{on}$	Turn-On Switching Loss	--		36	--	$\mu J$	
$E_{off}$	Turn-Off Switching Loss	--		27	--	$\mu J$	
$E_{ts}$	Total Switching Loss	--		63	100	$\mu J$	
$Q_g$	Total Gate Charge	$V_{CE} = 300V, I_C = 1.2A,$ $V_{GE} = 15V$		--	9	14	nC
$Q_{ge}$	Gate-Emitter Charge			--	3	5	nC
$Q_{gc}$	Gate-Collector Charge			--	1.5	3	nC
$L_e$	Internal Emitter Inductance	Measured 5mm from PKG	--	7.5	--	nH	

**Electrical Characteristics of DIODE**  $T_C = 25^\circ\text{C}$  unless otherwise noted

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units	
$V_{FM}$	Diode Forward Voltage	$I_F = 2A$	$T_C = 25^\circ\text{C}$	--	1.4	1.7	V
			$T_C = 100^\circ\text{C}$	--	1.3	--	
$t_{rr}$	Diode Reverse Recovery Time	$I_F = 2A,$ $di/dt = 200A/\mu s$	$T_C = 25^\circ\text{C}$	--	45	80	ns
			$T_C = 100^\circ\text{C}$	--	75	--	
$I_{rr}$	Diode Peak Reverse Recovery Current	$I_F = 2A,$ $di/dt = 200A/\mu s$	$T_C = 25^\circ\text{C}$	--	1.5	3.0	A
			$T_C = 100^\circ\text{C}$	--	2.5	--	
$Q_{rr}$	Diode Reverse Recovery Charge	$I_F = 2A,$ $di/dt = 200A/\mu s$	$T_C = 25^\circ\text{C}$	--	60	135	nC
			$T_C = 100^\circ\text{C}$	--	120	--	

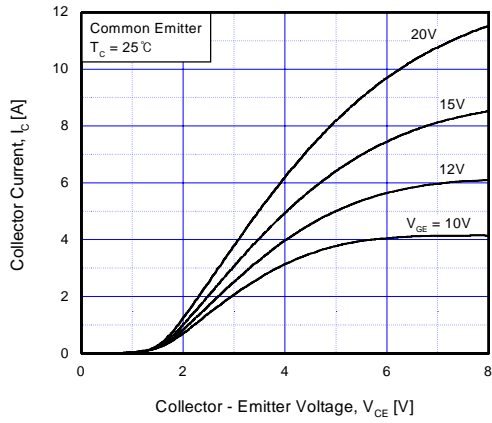


Fig 1. Typical Output Characteristics

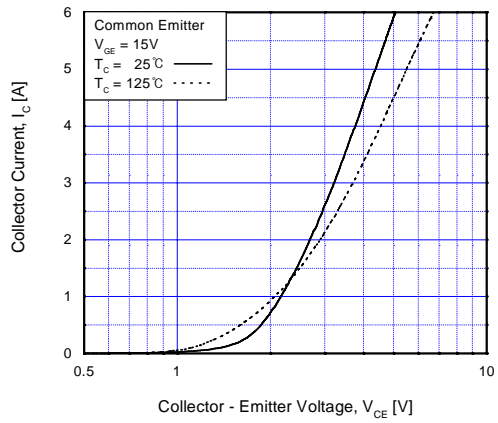


Fig 2. Typical Saturation Voltage Characteristics

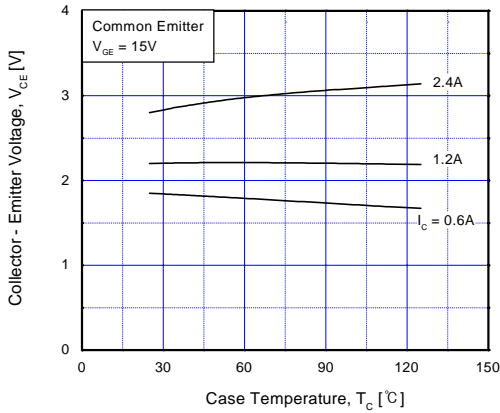


Fig 3. Saturation Voltage vs. Case Temperature at Variant Current Level

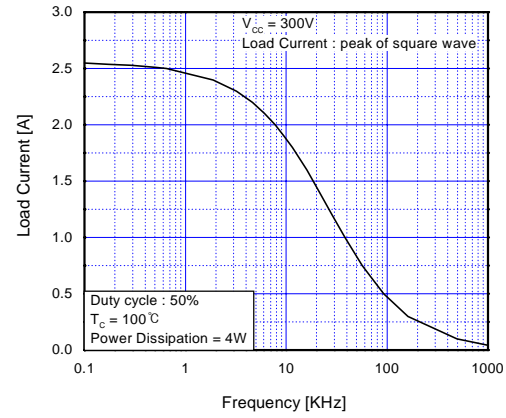


Fig 4. Load Current vs. Frequency

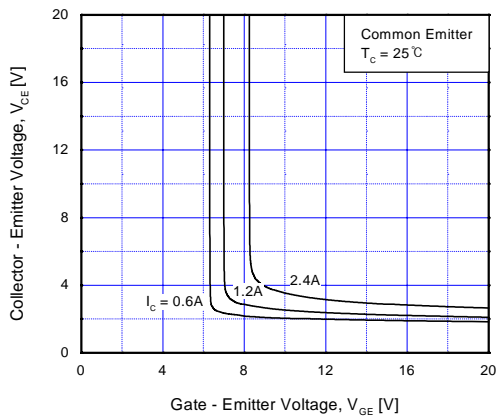


Fig 5. Saturation Voltage vs.  $V_{GE}$

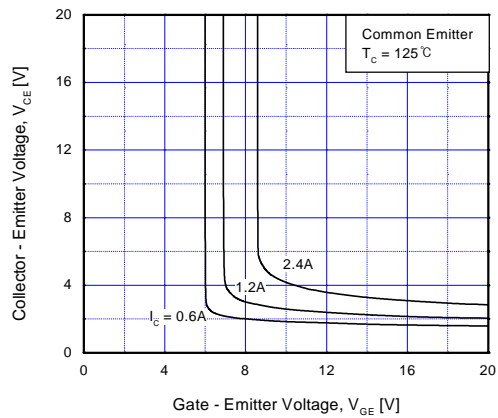
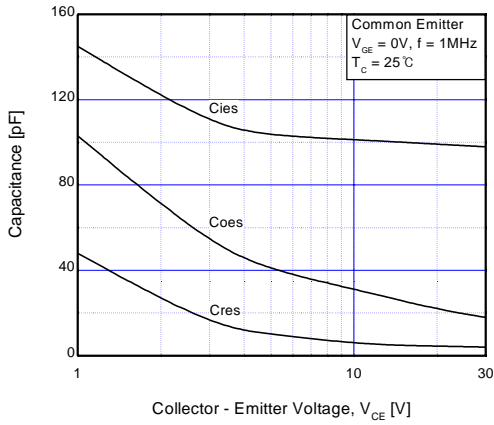
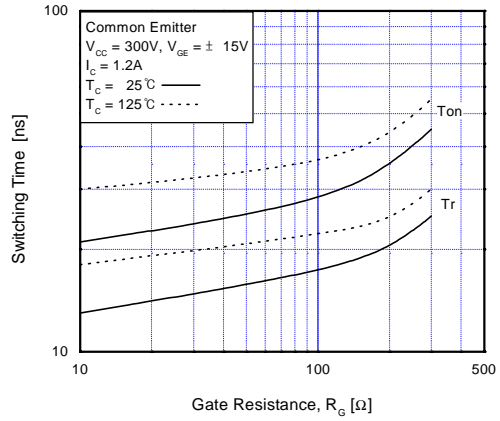


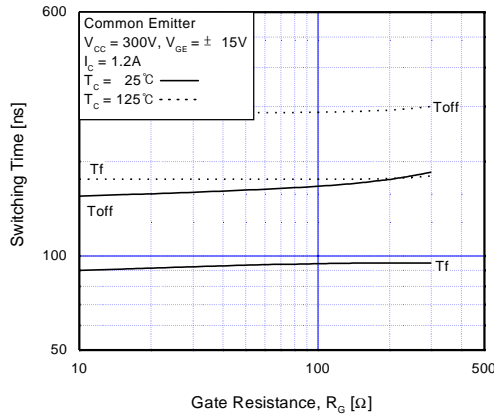
Fig 6. Saturation Voltage vs.  $V_{GE}$



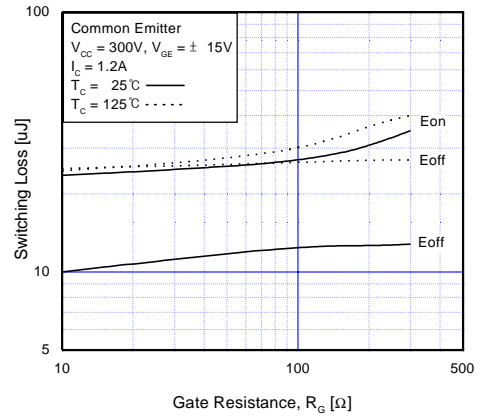
**Fig 7. Capacitance Characteristics**



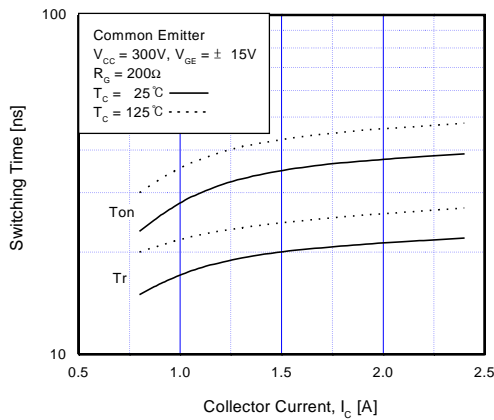
**Fig 8. Turn-On Characteristics vs. Gate Resistance**



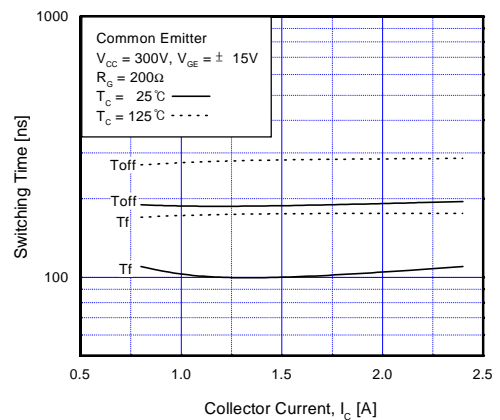
**Fig 9. Turn-Off Characteristics vs. Gate Resistance**



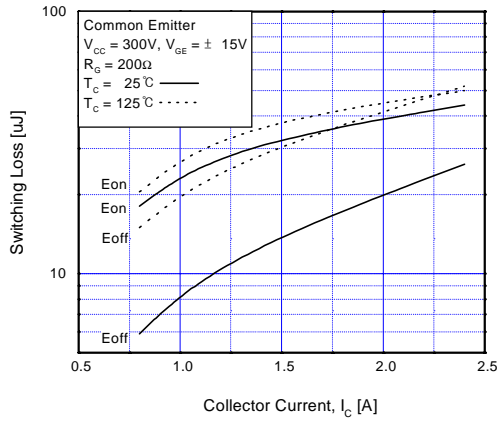
**Fig 10. Switching Loss vs. Gate Resistance**



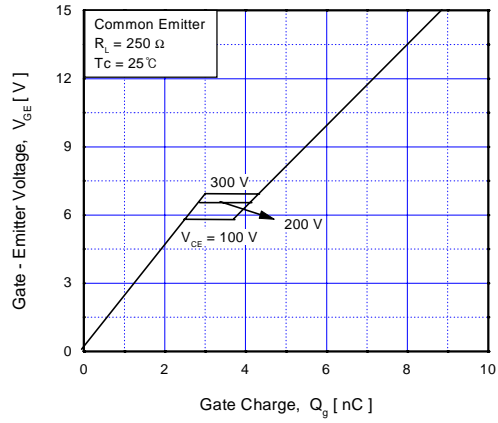
**Fig 11. Turn-On Characteristics vs. Collector Current**



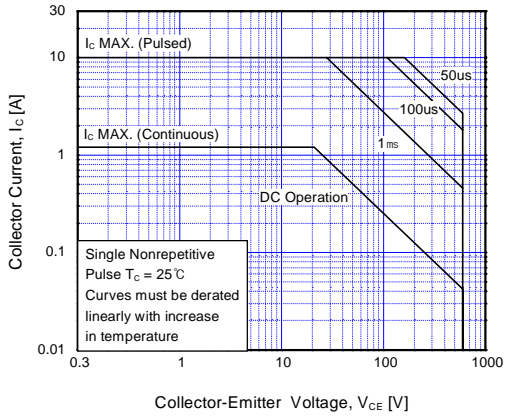
**Fig 12. Turn-Off Characteristics vs. Collector Current**



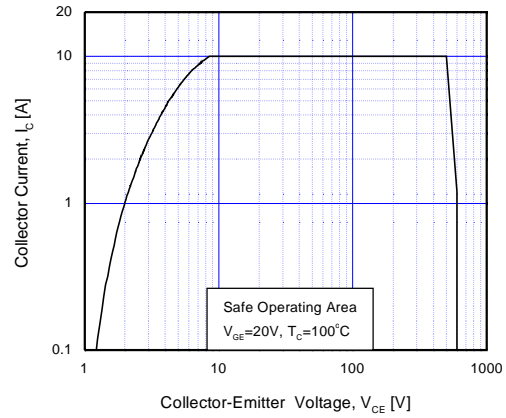
**Fig 13. Switching Loss vs. Collector Current**



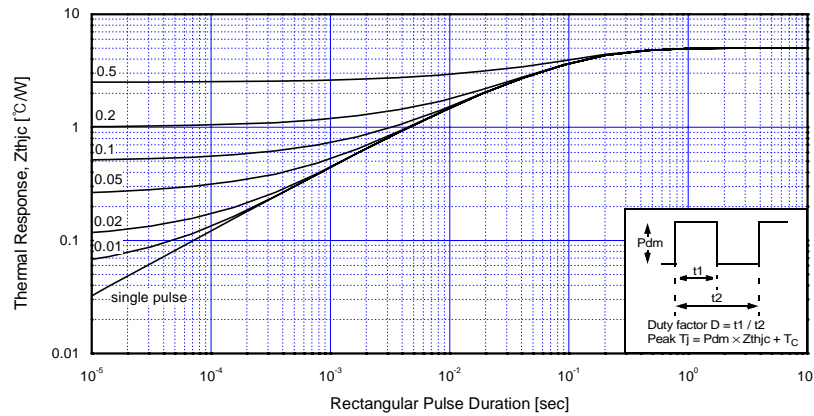
**Fig 14. Gate Charge Characteristics**



**Fig 15. SOA Characteristics**



**Fig 16. Turn-Off SOA Characteristics**



**Fig 17. Transient Thermal Impedance of IGBT**

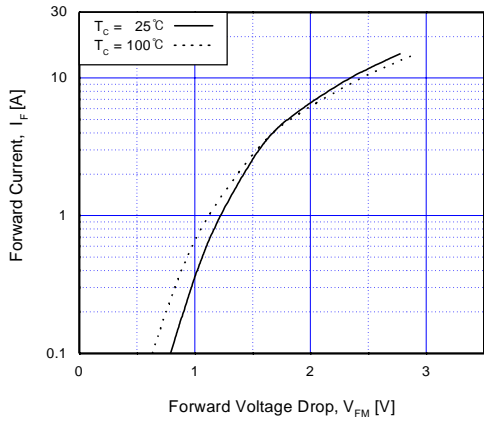


Fig 18. Forward Characteristics

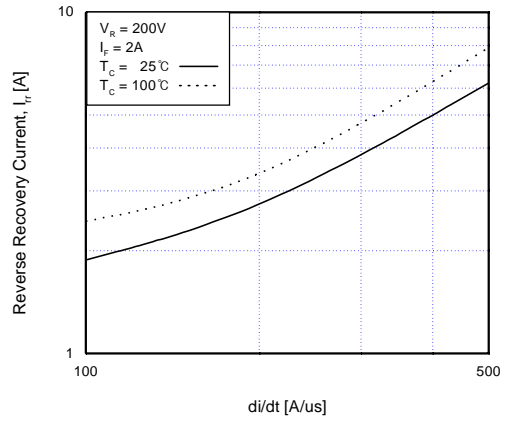


Fig 19. Reverse Recovery Current

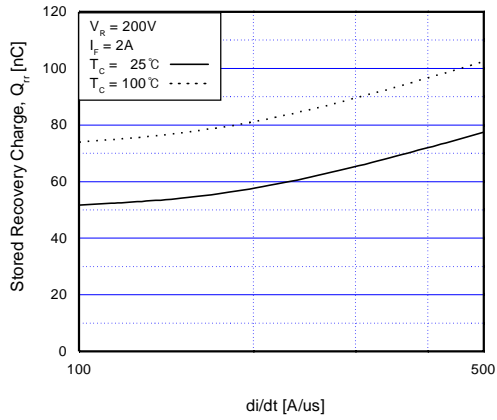


Fig 20. Stored Charge

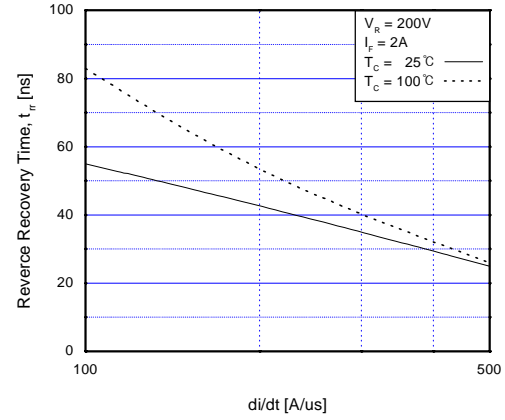
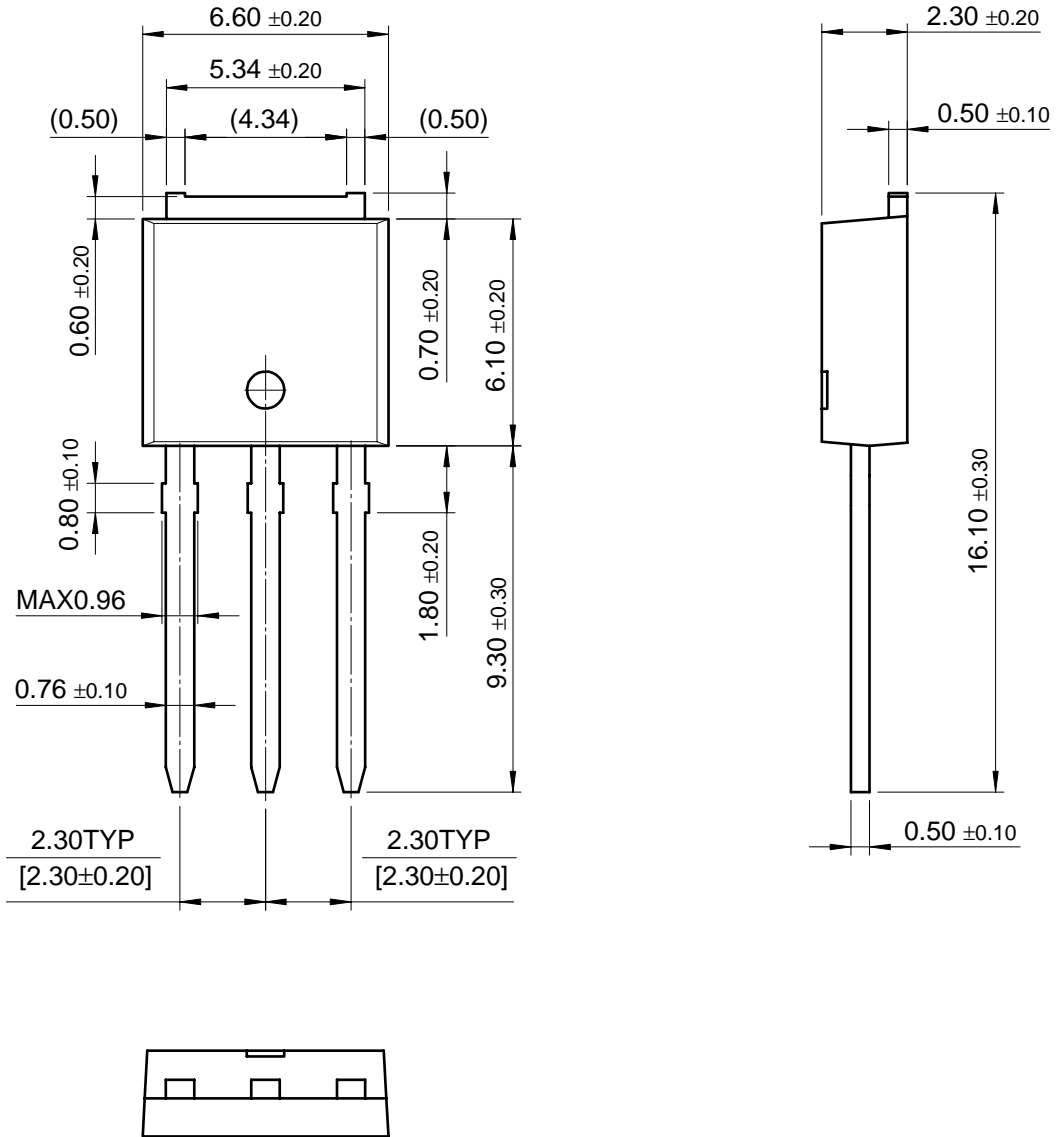


Fig 21. Reverse Recovery Time

Package Dimension

I-PAK



Dimensions in Millimeters

## TRADEMARKS

The following are registered and unregistered trademarks Fairchild Semiconductor owns or is authorized to use and is not intended to be an exhaustive list of all such trademarks.

ACEx™	FAST®	MICROWIRE™	SLIENT SWITCHER®	UHC™
Bottomless™	FASTr™	OPTOLOGIC™	SMART START™	UltraFET®
CoolFET™	FRFET™	OPTOPLANAR™	SPM™	VCX™
CROSSVOLT™	GlobalOptoisolator™	PACMAN™	STAR*POWER™	
DenseTrench™	GTO™	POPT™	Stealth™	
DOMETM	HiSeC™	Power247™	SuperSOT™-3	
EcoSPARK™	I <sup>2</sup> C™	PowerTrench®	SuperSOT™-6	
E <sup>2</sup> CMOS™	ISOPLANAR™	QFET™	SuperSOT™-8	
EnSigna™	LittleFET™	QST™	SyncFET™	
FACT™	MicroFET™	QT Optoelectronics™	TinyLogic™	
FACT Quiet Series™	MicroPak™	Quiet Series™	TruTranslation™	

STAR\*POWER is used under license

## DISCLAIMER

FAIRCHILD SEMICONDUCTOR RESERVES THE RIGHT TO MAKE CHANGES WITHOUT FURTHER NOTICE TO ANY PRODUCTS HEREIN TO IMPROVE RELIABILITY, FUNCTION OR DESIGN. FAIRCHILD DOES NOT ASSUME ANY LIABILITY ARISING OUT OF THE APPLICATION OR USE OF ANY PRODUCT OR CIRCUIT DESCRIBED HEREIN; NEITHER DOES IT CONVEY ANY LICENSE UNDER ITS PATENT RIGHTS, NOR THE RIGHTS OF OTHERS.

## LIFE SUPPORT POLICY

FAIRCHILD'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF FAIRCHILD SEMICONDUCTOR CORPORATION.

As used herein:

1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, or (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in significant injury to the user.
2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

## PRODUCT STATUS DEFINITIONS

### Definition of Terms

Datasheet Identification	Product Status	Definition
Advance Information	Formative or In Design	This datasheet contains the design specifications for product development. Specifications may change in any manner without notice.
Preliminary	First Production	This datasheet contains preliminary data, and supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice in order to improve design.
No Identification Needed	Full Production	This datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice in order to improve design.
Obsolete	Not In Production	This datasheet contains specifications on a product that has been discontinued by Fairchild semiconductor. The datasheet is printed for reference information only.



Fairchild Semiconductor

SEARCH | [Parametric](#) | [Cross Reference](#)

space

Product Folders and

Applies

find products

[Home](#) >> [Find products](#) >>[Products groups](#)[Analog and Mixed](#)[Signal](#)[Discrete](#)[Interface](#)[Logic](#)[Microcontrollers](#)[Non-Volatile](#)[Memory](#)[Optoelectronics](#)[Markets and](#)[applications](#)[New products](#)[Product selection and](#)[parametric search](#)[Cross-reference](#)[search](#)

## SGU2N60UFD

Discrete, High Performance IGBT with Diode

## Contents

[General description](#) | [Features](#) | [Applications](#) |[Product status/pricing/packaging](#) | [Models](#)

## Datasheet

[Download this  
datasheet](#)

PDF

[e-mail this datasheet](#)

[E-]

This page [Print version](#)

## Related Links

[Request samples](#)[Dotted line](#)[How to order products](#)[Dotted line](#)[Product Change Notices](#)[\(PCNs\)](#)[Dotted line](#)[Support](#)[Dotted line](#)[Distributor and field sales](#)[representatives](#)[Dotted line](#)[Quality and reliability](#)[Dotted line](#)[Design tools](#)

## General description

Fairchild's UFD series of Insulated Gate Bipolar Transistors (IGBTs) provides low conduction and switching losses. The UFD series is designed for applications such as motor control and general inverters where high speed switching is a required feature.

[back to top](#)

## Features

- High Speed Switching
- Low Saturation Voltage :  $V_{CE(sat)} = 2.1$  V @  $I_C = 1.2$ A
- High Input Impedance
- CO-PAK, IGBT with FRD :  $t_{rr} = 45$ ns (typ.)

[back to top](#)

## Applications

AC &DC Motor controls, General Purpose Inverters, Robotics, Servo Controls

[back to top](#)[Product status/pricing/packaging](#)[technical information](#)[buy products](#)[technical support](#)[my Fairchild](#)[company](#)

Product	Product status	Pricing*	Package type	Leads	Packing method
SGU2N60UFDTU	Full Production	\$0.63	TO-251(IPAK)	3	RAIL

\* 1,000 piece Budgetary Pricing

[back to top](#)

Models

Package & leads	Condition	Temperature range	Software version	Revision date
PSPICE				
TO-251(IPAK)-3	<a href="#">Electrical</a>	25°C	9.2	Jun 28, 2002

[back to top](#)

[Home](#) | [Find products](#) | [Technical information](#) | [Buy products](#) | [Support](#) | [Company](#) | [Contact us](#) | [Site index](#) | [Privacy policy](#)

© Copyright 2002 Fairchild Semiconductor